

Atty. Docket No. OPP031054US
Serial No: 10/734,818

Amendments to the Specification

Please replace the Title beginning at page 1, line 1, with the following replacement Title:

**METHODS TO FABRICATE FOR FABRICATING A SEMICONDUCTOR DEVICE
WITH ETCH END POINT DETECTION**

Please replace paragraph [0001] beginning at page 1, line 4 with the following replacement paragraph:

[0001] This disclosure relates generally to semiconductor devices,[[.]] and more particularly to methods ~~to fabricate~~ for fabricating a semiconductor device using end point detection during a hole etching process.